

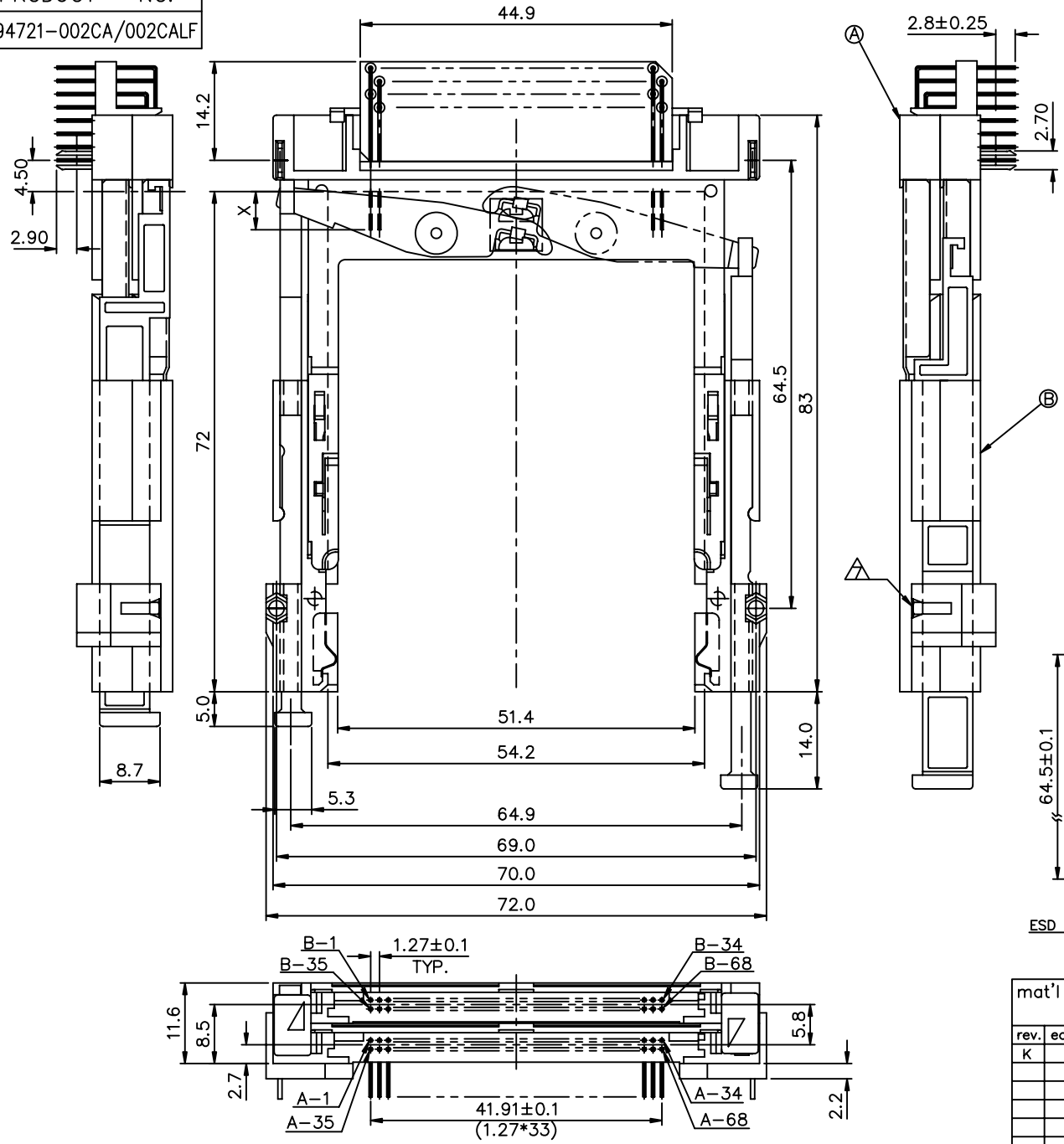


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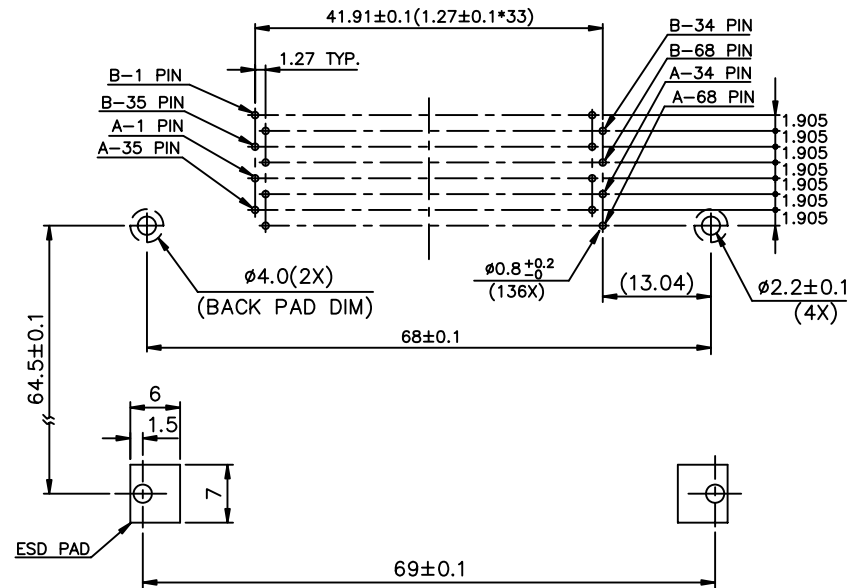
PRODUCT NO.  
94721-002CA/002CALF



- NOTES:
- EJECT FORCE 3.5 Kg MAX.
  - ASS'Y PROCESS
  - 2.1 TO MOUNT PART A ON PWB WITH HOLD DOWN(S1,S2)AND SOLDER THEN FIX PART B WITH TWO SCREWS.
  - EJECT TRAVEL: 9.0mm
  - MATERIAL
    - PART A (HEADER ASS'Y)  
PLASTIC :HOUSING ...LCP UL94V-0 BLACK  
LOCATOR ...G.F. 6/6 NYLON UL94-V0 BLACK  
PIN :PHOSPHOR BRONZE
    - PART B (EJECT MECHANISM ASS'Y)  
PLASTIC :GUIDE: POLYPHTHARAMID UL94V-0 BLACK  
:PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK  
PLATE :STAINLESS  
EMI CONTACT:PHOSPHOR BRONZE
  - FINISH (PIN)  
UNDER PLATING :0.5µm MIN. Ni  
CONTACT AREA :0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni  
SOLDER TAIL : 2.5µm MIN. Sn-Pb  
: 2.5µm MIN. PURE Sn ( FOR -\*\*\*\*\*LF )

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68

- △NUT M2\*0.4P (2X) RETENTION FORCE : 1Kg MIN.
- IF LEAD FREE P/N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
  - IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
  - LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



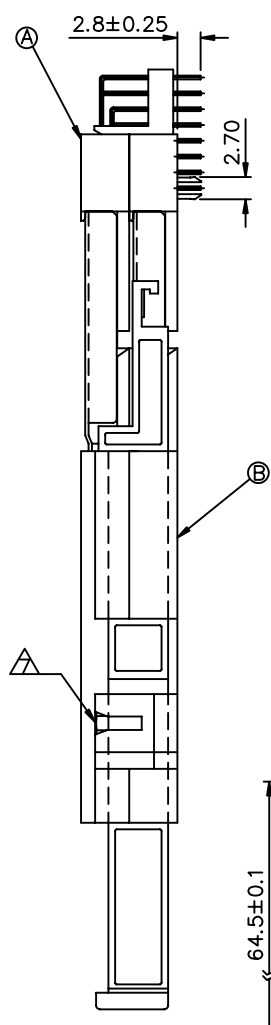
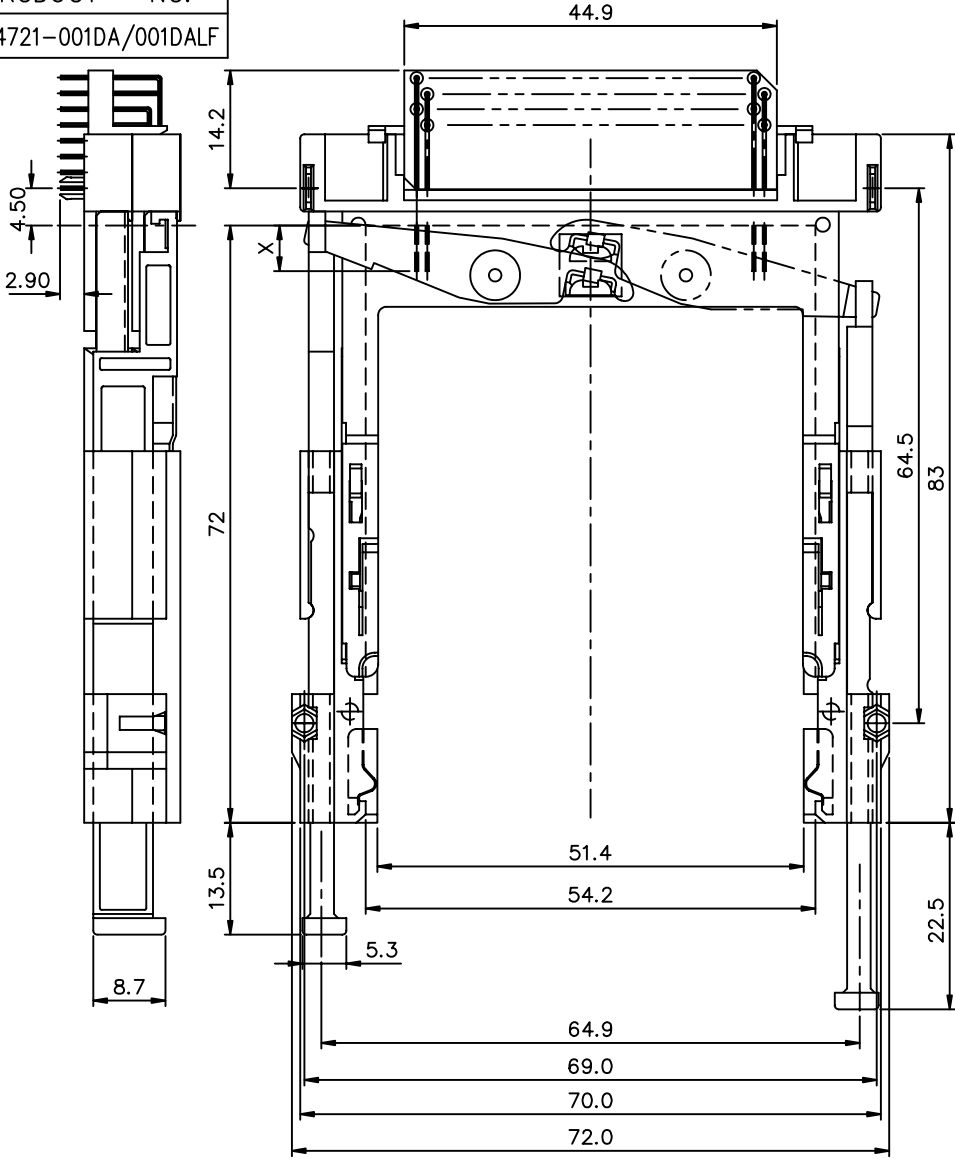
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rev.	ecn no.	dr	date	linear	0. ± 0.50	projection	title 68POS. EJECTOR HEADER ASS'Y FOR TYPE 1/2/3		
K				angles	.0 ± 0.30		product family		code
				dr	.00 ± 0.15		size	dwg no.	
				enr	± 2'	mm/inch	94721		sheet
				chr		scale			2 OF
				appd		1.5:1			
sheet	revision								
index	sheet								

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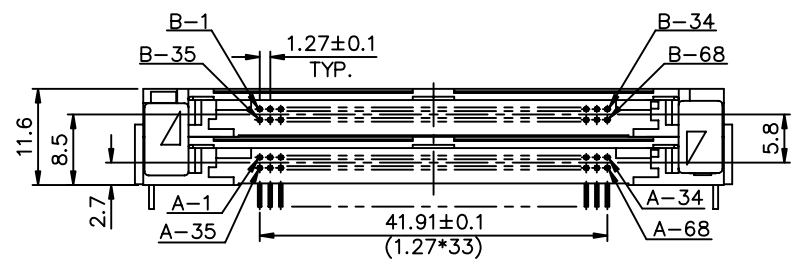
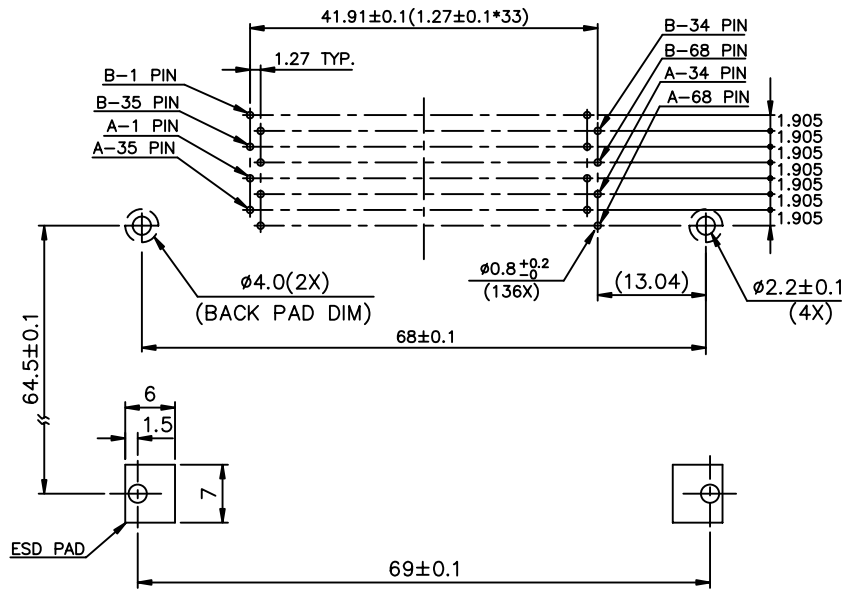
PRODUCT NO.  
94721-001DA/001DALF



NOTES:

1. EJECT FORCE 3.5 Kg MAX.
2. ASS'Y PROCESS
- 2.1 TO MOUNT PART (A) ON PWB WITH HOLD DOWN (S1,S2) AND SOLDER THEN FIX PART (B) WITH TWO SCREWS.
3. EJECT TRAVEL: 9.0mm
4. MATERIAL
  - 4.1 PART (A) (HEADER ASS'Y)  
PLASTIC : HOUSING ...LCP UL94V-0 BLACK  
LOCATOR ...G.F. 6/6 NYLON UL94-V0 BLACK  
PIN : PHOSPHOR BRONZE
  - 4.2 PART (B) (EJECT MECHANISM ASS'Y)  
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK  
: PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK  
PLATE : STAINLESS  
EMI CONTACT: PHOSPHOR BRONZE
5. FINISH (PIN)  
UNDER PLATING : 0.5µm MIN. Ni  
CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni  
SOLDER TAIL : 2.5µm MIN. Sn-Pb  
: 2.5µm MIN. PURE Sn ( FOR -\*\*\*\*LF )
6. DIM "X"
 

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
- △ NUT M2\*0.4P (2X) RETENTION FORCE : 1Kg MIN.
- 8 IF LEAD FREE P/N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM THICK CIRCUIT BOARD.
- 9 IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
- 10 LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



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rev.	ecn no.	dr	date	linear	0. ± 0.50	projection	title 68POS. EJECTOR HEADER ASS'Y FOR TYPE 1/2/3
K				.0 ± 0.30	.00 ± 0.15	⊕	
				angles	± 2'		
		dr	CATHY LIN	06/16/94	unit	mm/inch	product family
		enrg	JOSEPH HSIA	06/16/94	size	dwg no.	code
		chr	JOSEPH HSIA	06/16/94	scale	1.5:1	TWN
		appd	D K WANG	06/16/94		A3	94721
sheet	revision						sheet
index	sheet						3 OF



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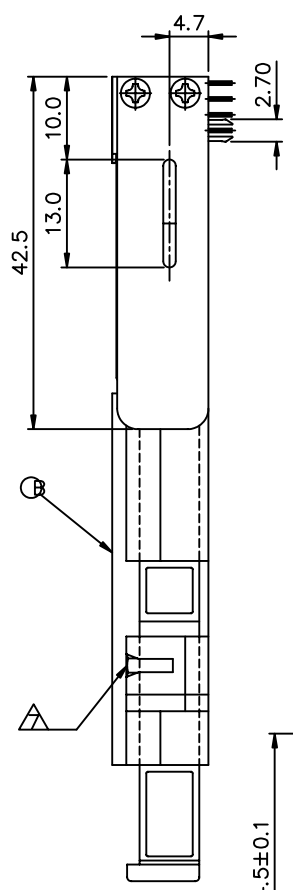
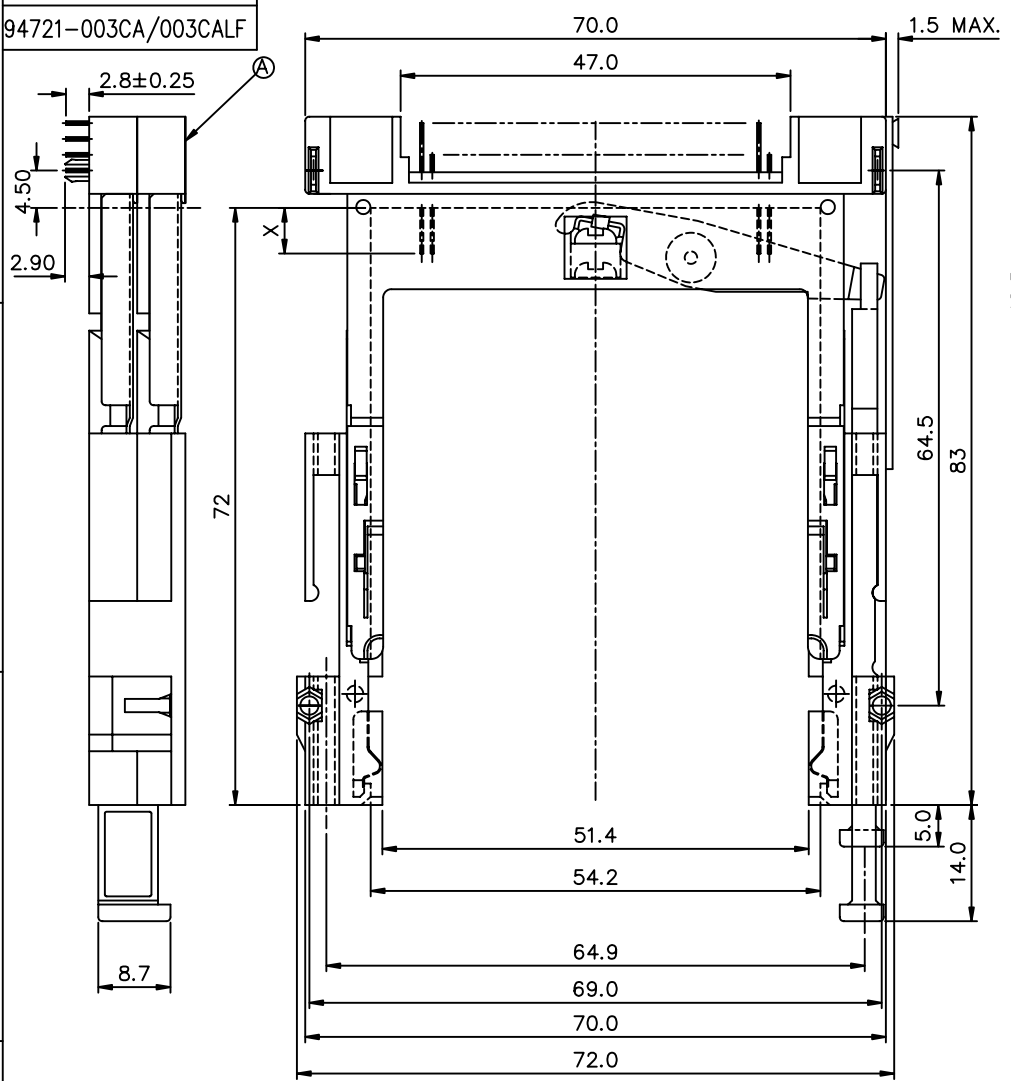
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PRODUCT NO.  
 94721-003CA/003CALF

A  
 B  
 C  
 D

1 | 2 | 3 | 4 | 5 | 6



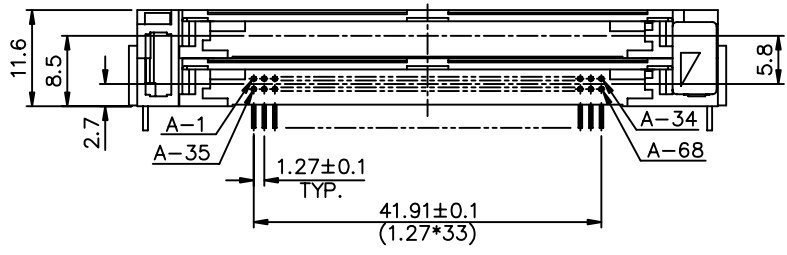
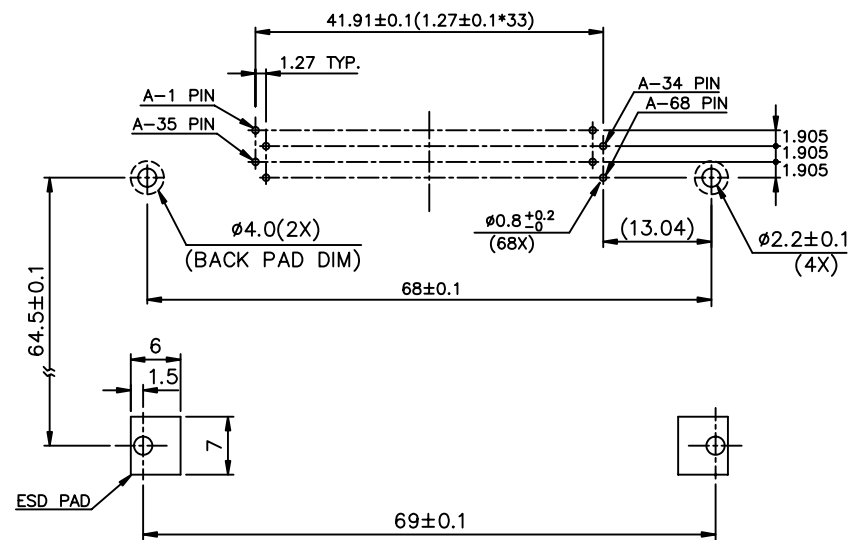
NOTES:

- EJECT FORCE 3.5 Kg MAX.
- ASS'Y PROCESS
- TO MOUNT PART (A) ON PWB WITH HOLD DOWN(S1,S2) AND SOLDER THEN FIX PART (B) WITH TWO SCREWS.
- EJECT TRAVEL: 9.0mm
- MATERIAL
  - PART (A) (HEADER ASS'Y)  
 PLASTIC : HOUSING ...LCP UL94V-0 BLACK  
 LOCATOR ....G.F. 6/6 NYLON UL94-V0 BLACK  
 PIN : PHOSPHOR BRONZE
  - PART (B) (EJECT MECHANISM ASS'Y)  
 PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK  
 PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK  
 PLATE : STAINLESS  
 EMI CONTACT: PHOSPHOR BRONZE
- FINISH (PIN)  
 UNDER PLATING : 0.5µm MIN. Ni  
 CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni  
 SOLDER TAIL : 2.5µm MIN. Sn-Pb  
 : 2.5µm MIN. PURE Sn ( FOR -\*\*\*\*\*LF )

DIM "X"	4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68	

NUT M2\*0.4P (2X) RETENTION FORCE : 1Kg MIN.

- IF LEAD FREE P.N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
- LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



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rev.	ecn no.	dr	date	linear	0. ± 0.50	projection	title 68POS. EJECTOR HEADER ASS'Y FOR TYPE 1/2/3		
K				angles	.0 ± 0.30		product family		
				dr	.00 ± 0.15	unit	size		code
				enr	± 2°	mm/inch	dwg no.		TWN
				chr		scale	94721		sheet
				appd		1.5:1	5 OF		
sheet	revision								
index	sheet								



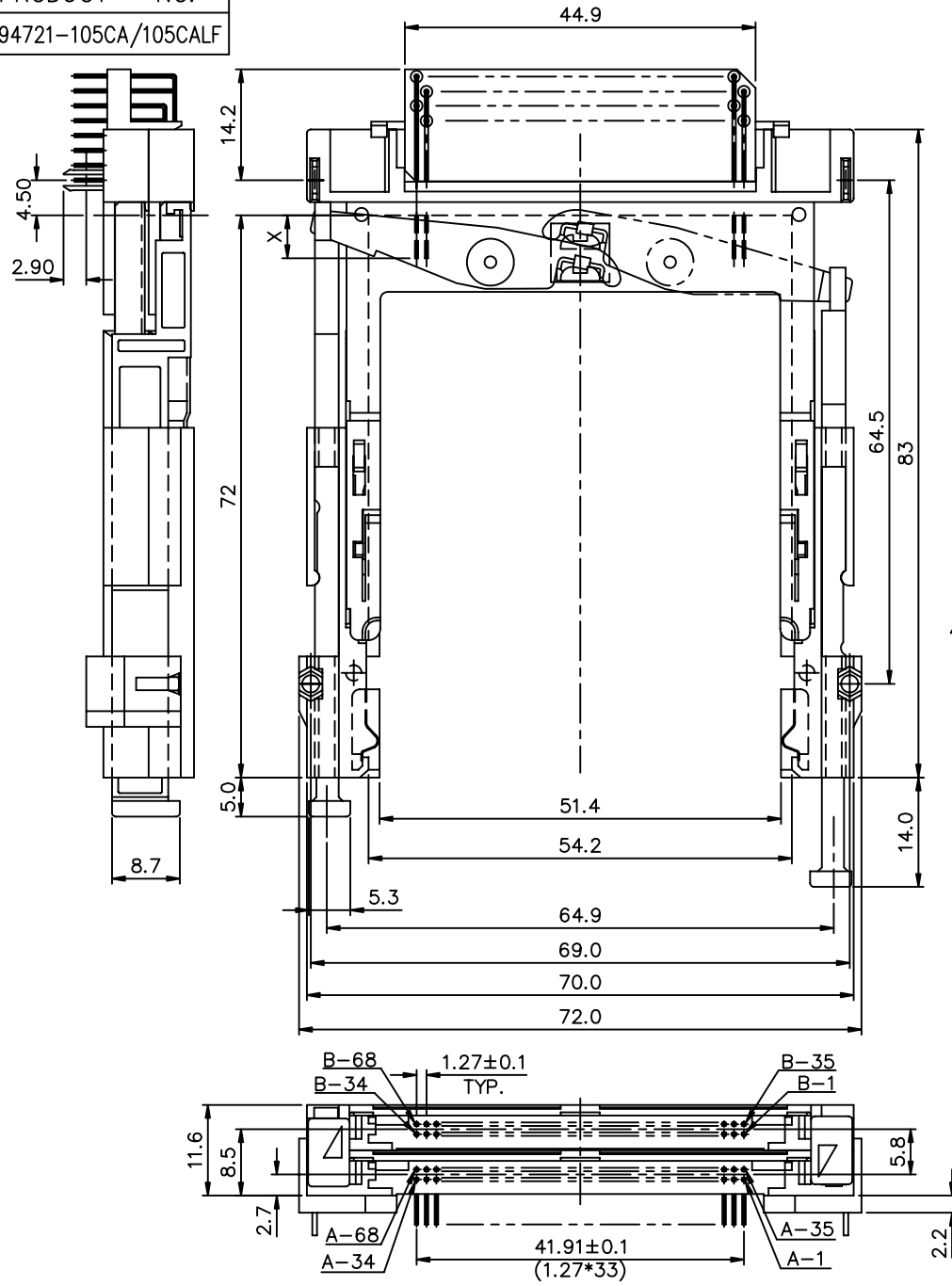


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PRODUCT NO.  
 94721-105CA/105CALF

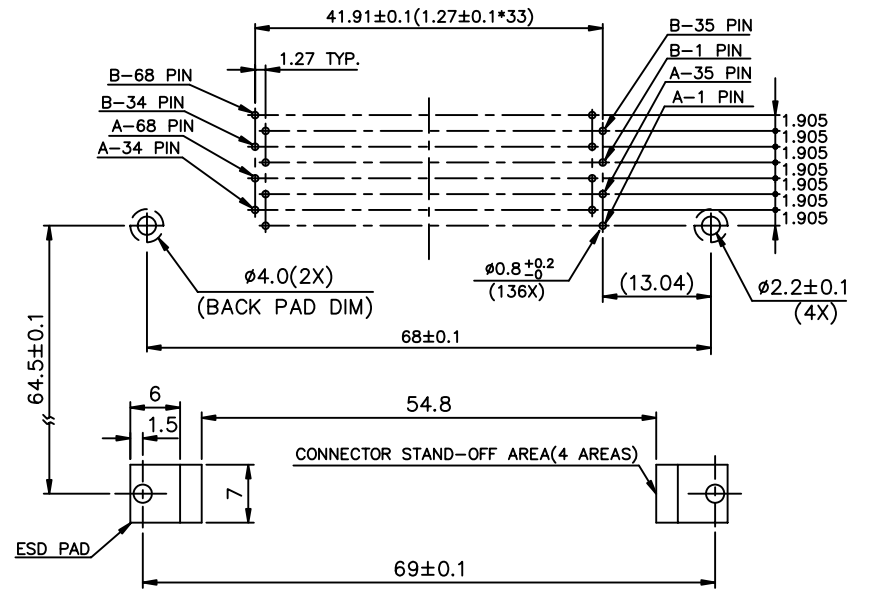


NOTES:

- EJECT FORCE 3.5 Kg MAX.
- ASS'Y PROCESS
- 2.1 TO MOUNT PART (A) ON PWB WITH HOLD DOWN(S1,S2) AND SOLDER THEN FIX PART (B) WITH TWO SCREWS.
- EJECT TRAVEL: 9.0mm
- MATERIAL
  - PART (A) (HEADER ASS'Y)  
 PLASTIC : HOUSING ...LCP UL94V-0 BLACK  
 LOCATOR ....G.F. 6/6 NYLON UL94-V0 BLACK  
 PIN : PHOSPHOR BRONZE
  - PART (B) (EJECT MECHANISM ASS'Y)  
 PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK  
 : PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK  
 PLATE : STAINLESS  
 EMI CONTACT: PHOSPHOR BRONZE
- FINISH (PIN)  
 UNDER PLATING : 0.5µm MIN. Ni  
 CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni  
 SOLDER TAIL : 2.5µm MIN. Sn-Pb  
 : 2.5µm MIN. PURE Sn ( FOR -\*\*\*\*\*LF )

DIM "X"	4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68	

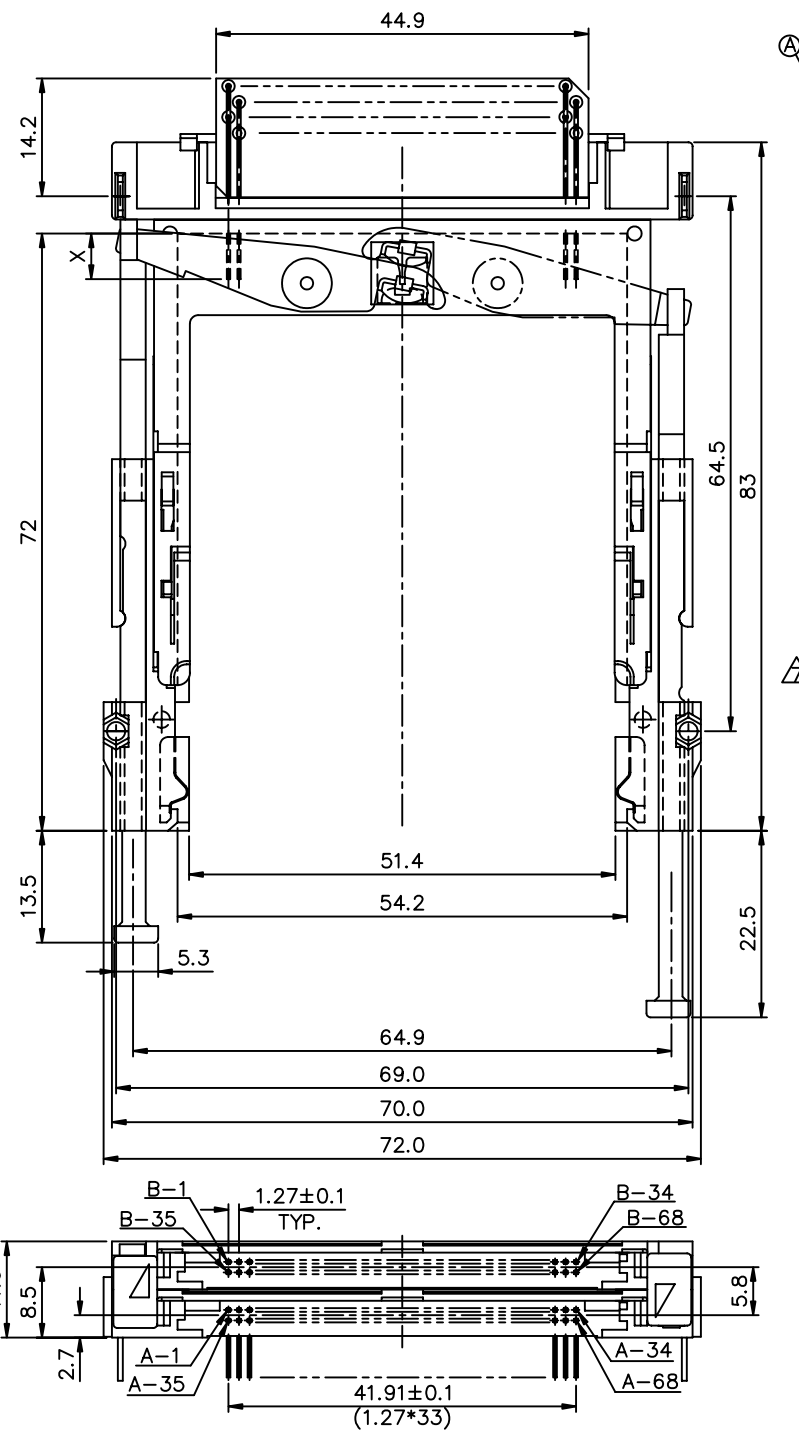
- △ NUT M2\*0.4P (2X) RETENTION FORCE : 1Kg MIN.
- IF LEAD FREE P/N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
  - IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
  - LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



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rev.	ecn no.	dr	date	linear	0. ± 0.50	projection	title 68POS. EJECTOR HEADER ASS'Y FOR TYPE 1/2/3		
K				angles	.0 ± 0.30	⊕	product family		
				dr	.00 ± 0.15	mm/inch	size	dwg no.	
				enr	± 2'	scale	A3	94721	
				chr		1.5:1	code TWN		
				appd			sheet 7 OF		
sheet	revision								
index	sheet								

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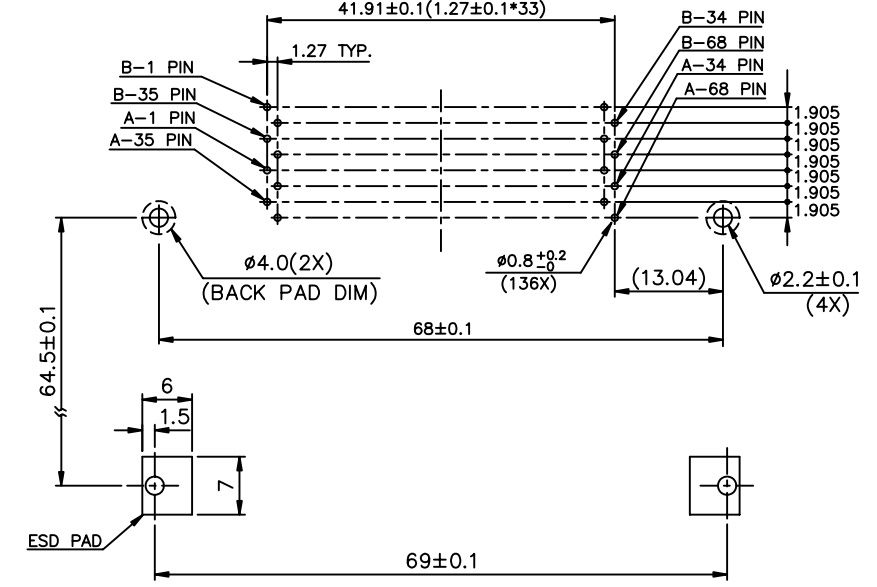
PRODUCT NO.  
94721-003DA/003DALF



- NOTES:
- EJECT FORCE 3.5 Kg MAX.
  - ASS'Y PROCESS
    - TO MOUNT PART (A) ON PWB WITH HOLD DOWN(S1,S2)AND SOLDER THEN FIX PART (B) WITH TWO SCREWS.
  - EJECT TRAVEL: 9.0mm
  - MATERIAL
    - PART (A) (HEADER ASS'Y)  
 PLASTIC : HOUSING ...LCP UL94V-0 BLACK  
 LOCATOR ...G.F. 6/6 NYLON UL94-V0 BLACK  
 PIN : PHOSPHOR BRONZE
    - PART (B) (EJECT MECHANISM ASS'Y)  
 PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK  
 : PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK  
 PLATE : STAINLESS  
 EMI CONTACT: PHOSPHOR BRONZE
  - FINISH (PIN)  
 UNDER PLATING : 0.5µm MIN. Ni  
 CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni  
 SOLDER TAIL : 2.5µm MIN. Sn-Pb  
 : 2.5µm MIN. PURE Sn ( FOR -\*\*\*\*LF )

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68

- (A) NUT M2\*0.4P (2X) RETENTION FORCE : 1Kg MIN.  
 8 IF LEAD FREE P.N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.  
 9 IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008  
 10 LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



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rev.	ecn no.	dr	date	linear	0. ± 0.50	projection	title 68POS. EJECTOR HEADER ASS'Y FOR TYPE 1/2/3
F					.0 ± 0.30		
				angles	.00 ± 0.15		product family
				dr	± 2'		code
				enr		unit	TWN
				chr	WENDY CHEN 03/23/95	mm/inch	sheet
				appd	JOSEPH HSIA 03/23/95	scale	8 OF
					JOSEPH HSIA 03/23/95	1.5:1	
					D K WANG 03/23/95		
sheet	revision						
index	sheet						

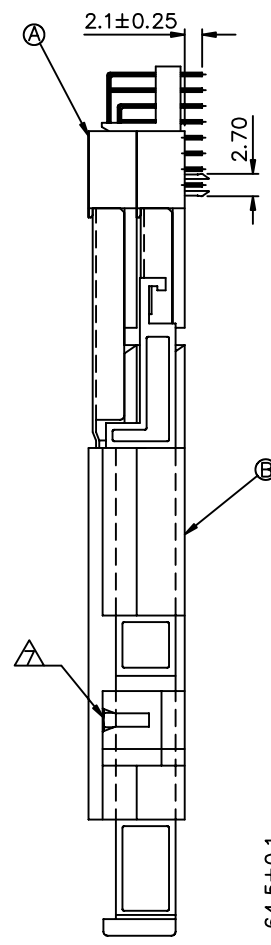
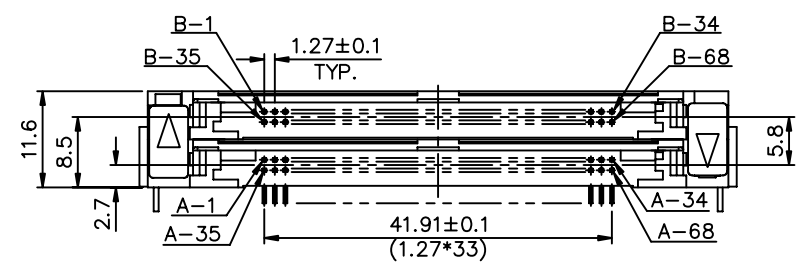
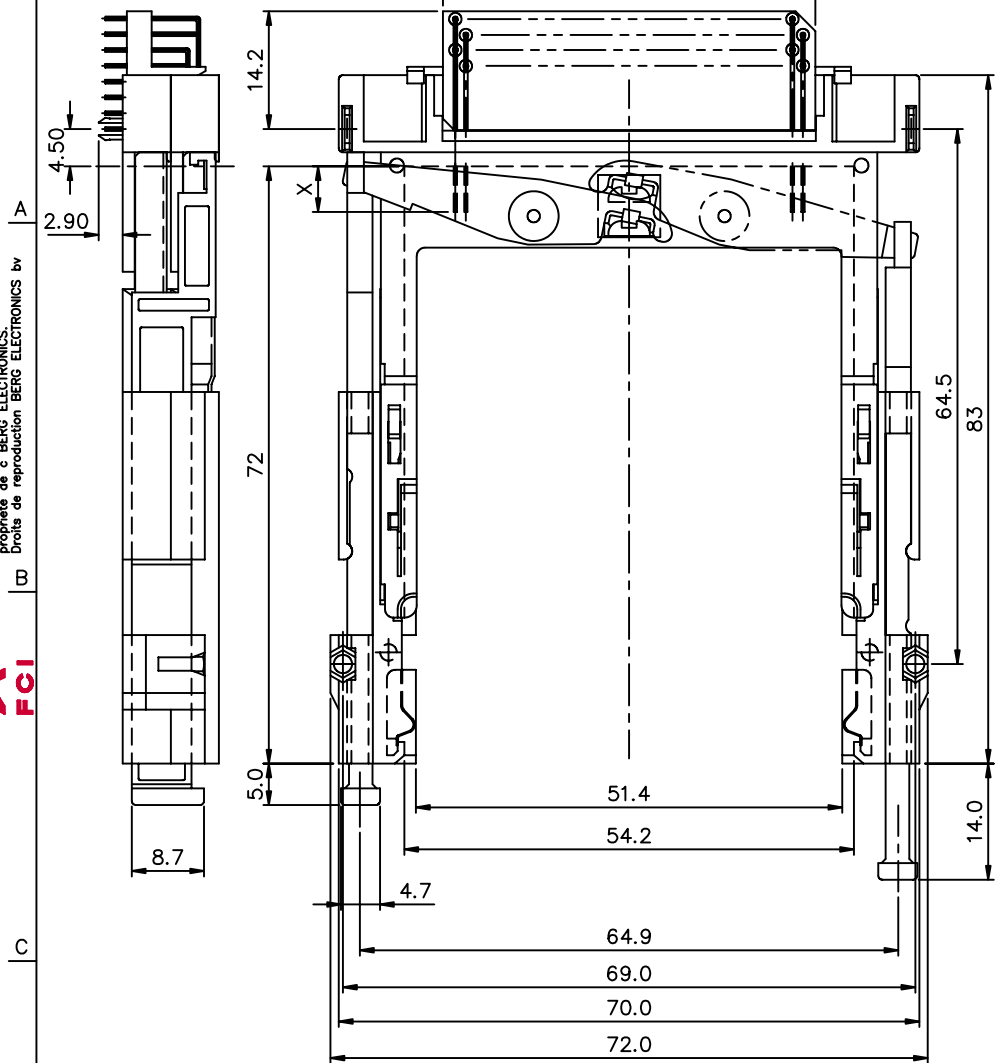


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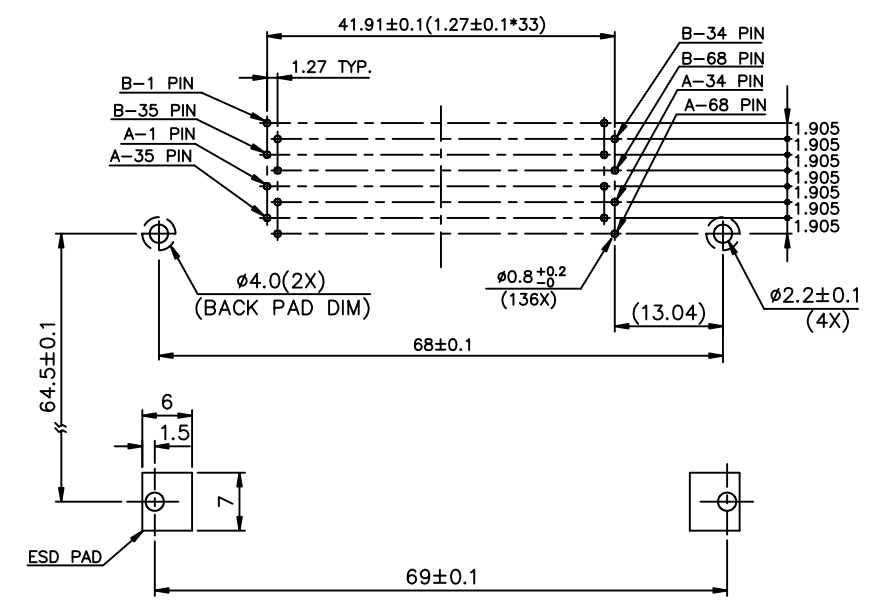
PRODUCT NO.  
 94721-005CA/005CALF



- NOTES:
- EJECT FORCE 3.5 Kg MAX.
  - ASS'Y PROCESS
    - TO MOUNT PART (A) ON PWB WITH HOLD DOWN(S1,S2)AND SOLDER THEN FIX PART (B) WITH TWO SCREWS.
  - EJECT TRAVEL: 9.0mm
  - MATERIAL
    - PART (A) (HEADER ASS'Y)  
 PLASTIC : HOUSING ...LCP UL94V-0 BLACK  
 LOCATOR ....G.F. 6/6 NYLON UL94-V0 BLACK  
 PIN : PHOSPHOR BRONZE
    - PART (B) (EJECT MECHANISM ASS'Y)  
 PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK  
 PLATE : STAINLESS  
 PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK  
 EMI CONTACT: PHOSPHOR BRONZE
  - FINISH (PIN)
 

UNDER PLATING : 0.5µm MIN. Ni	CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni
SOLDER TAIL : 2.5µm MIN. Sn-Pb	
	: 2.5µm MIN. PURE Sn ( FOR -*****LF )
  - DIM "X"
 

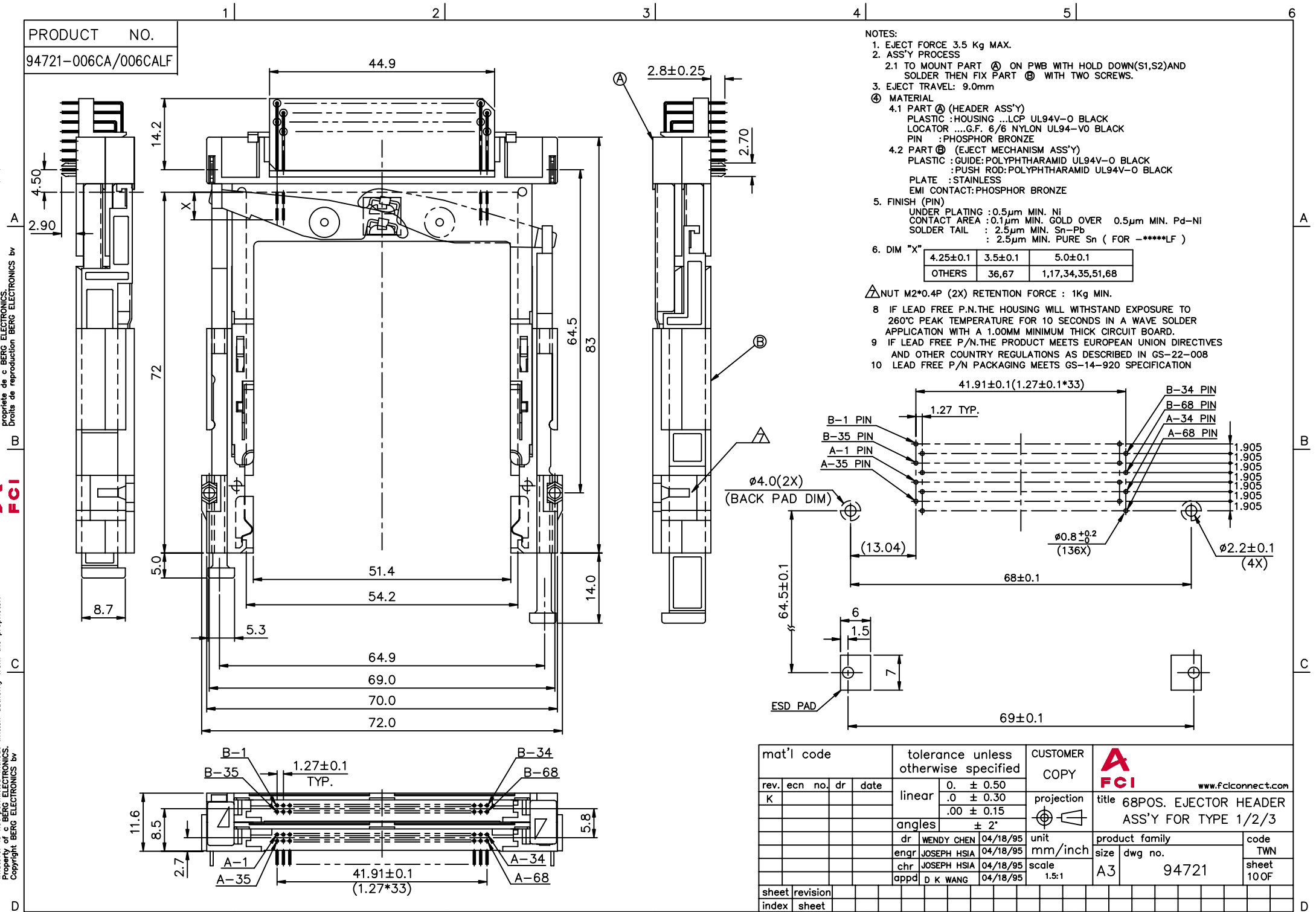
4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
- △NUT M2\*0.4P (2X) RETENTION FORCE : 1Kg MIN.
- IF LEAD FREE P/N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
  - IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
  - LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



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rev.	ecn no.	dr	date	linear	0. ± 0.50	projection	title 68POS. EJECTOR HEADER ASS'Y FOR TYPE 1/2/3
K					.0 ± 0.30		product family
				angles	.00 ± 0.15		size
		dr	WENDY CHEN	03/25/95	± 2'	mm/inch	dwg no.
		enr	JOSEPH HSIA	03/25/95		scale	94721
		chr	JOSEPH HSIA	03/25/95		1.5:1	sheet 9 OF
		appd	D K WANG	03/25/95			
sheet	revision						
index	sheet						

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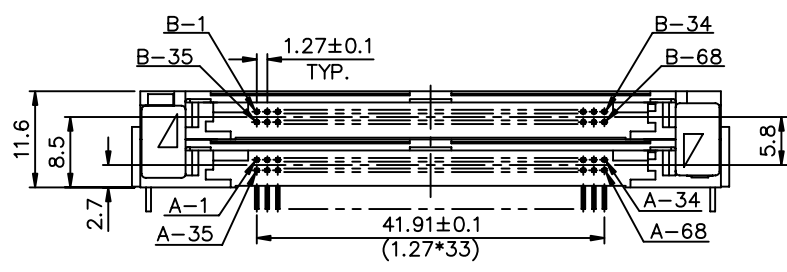
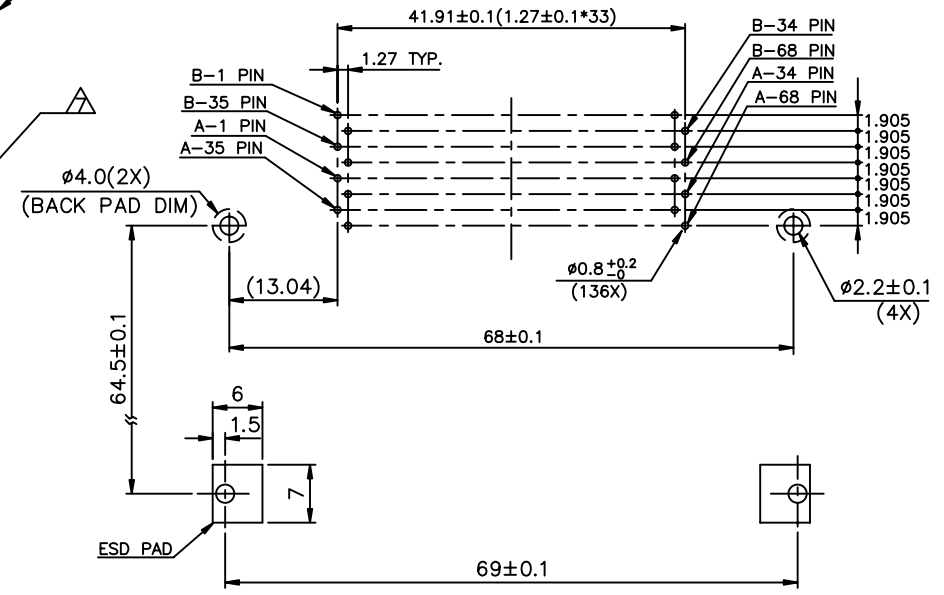
PRODUCT NO.  
94721-006CA/006CALF



- NOTES:
- EJECT FORCE 3.5 Kg MAX.
  - ASS'Y PROCESS
  - TO MOUNT PART (A) ON PWB WITH HOLD DOWN(S1,S2)AND SOLDER THEN FIX PART (B) WITH TWO SCREWS.
  - EJECT TRAVEL: 9.0mm
  - MATERIAL
    - PART (A) (HEADER ASS'Y)  
PLASTIC : HOUSING ...LCP UL94V-0 BLACK  
LOCATOR ...G.F. 6/6 NYLON UL94-V0 BLACK  
PIN : PHOSPHOR BRONZE
    - PART (B) (EJECT MECHANISM ASS'Y)  
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK  
: PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK  
PLATE : STAINLESS  
EMI CONTACT: PHOSPHOR BRONZE
  - FINISH (PIN)  
UNDER PLATING : 0.5µm MIN. Ni  
CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni  
SOLDER TAIL : 2.5µm MIN. Sn-Pb  
: 2.5µm MIN. PURE Sn ( FOR -\*\*\*\*\*LF )

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68

- △NUT M2\*0.4P (2X) RETENTION FORCE : 1Kg MIN.
- IF LEAD FREE P/N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
  - IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
  - LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



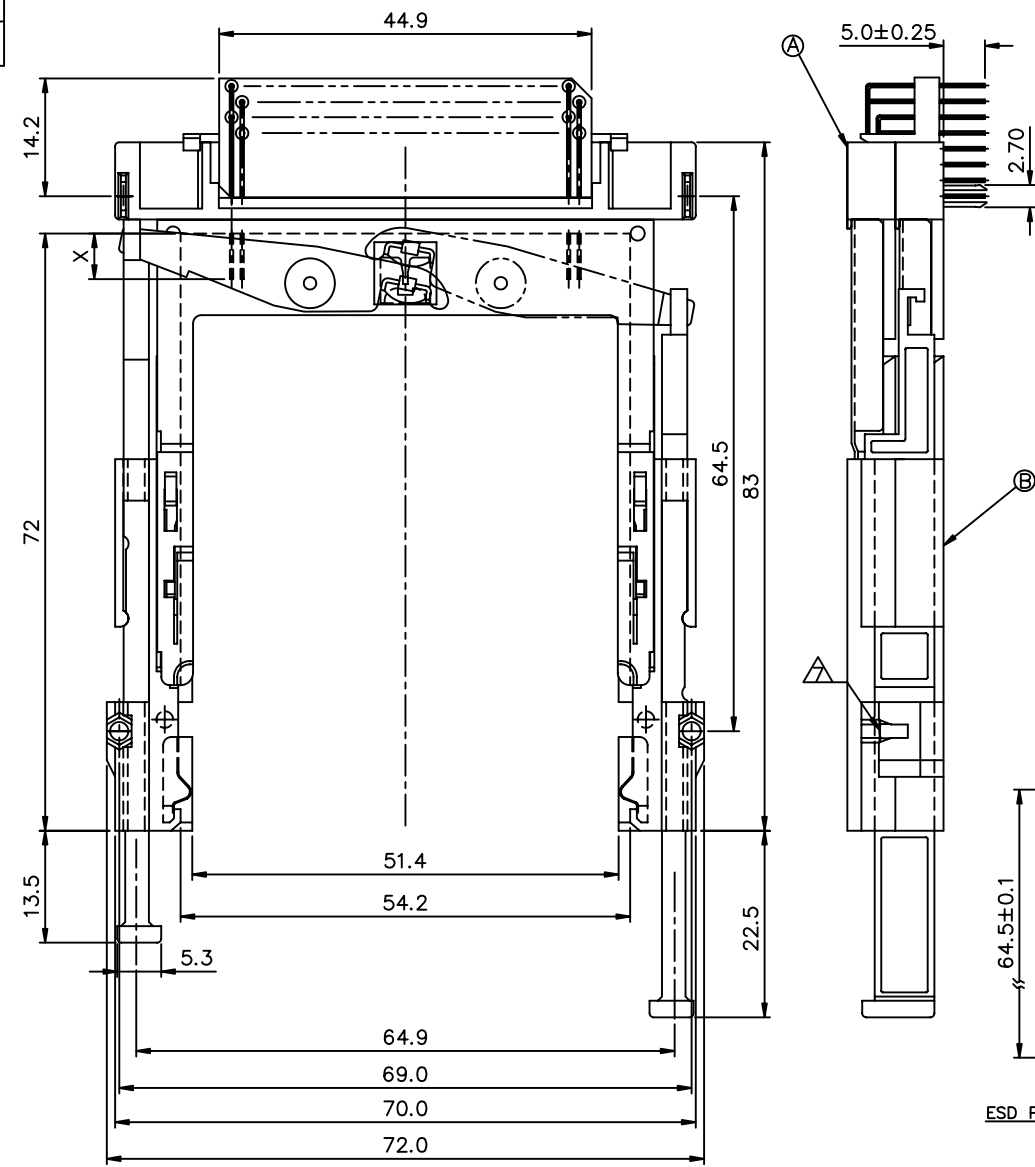
mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		A FCI		www.fciconnect.com	
rev.	ecn no.	dr	date	linear	0. ± 0.50	projection	title 68POS. EJECTOR HEADER ASS'Y FOR TYPE 1/2/3		
K				angles	.0 ± 0.30		product family		
					.00 ± 0.15		size	code	
		dr	WENDY CHEN	04/18/95	unit	mm/inch	product family		
		enr	JOSEPH HSIA	04/18/95	scale	1.5:1	code		
		chr	JOSEPH HSIA	04/18/95	scale	1.5:1	code		
		appd	D K WANG	04/18/95	scale	1.5:1	code		
sheet	revision								
index	sheet								

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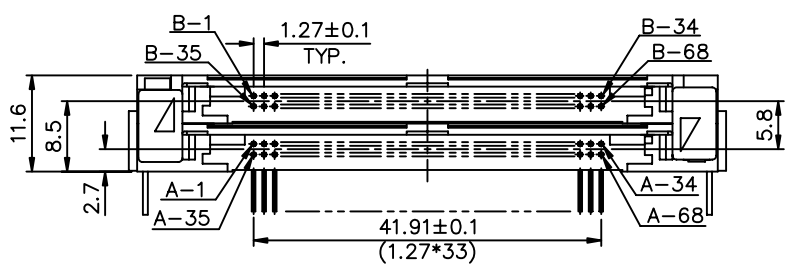
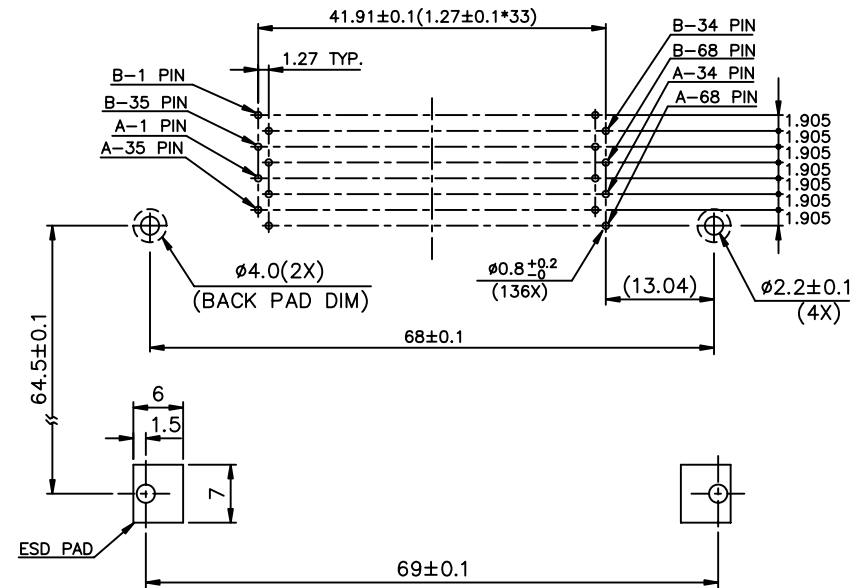
PRODUCT NO.  
94721-004DA/004DALF



- NOTES:
- EJECT FORCE 3.5 Kg MAX.
  - ASS'Y PROCESS
  - TO MOUNT PART (A) ON PWB WITH HOLD DOWN(S1,S2)AND SOLDER THEN FIX PART (B) WITH TWO SCREWS.
  - EJECT TRAVEL: 9.0mm
  - MATERIAL
    - PART (A) (HEADER ASS'Y)  
PLASTIC : HOUSING ...LCP UL94V-0 BLACK  
LOCATOR ...G.F. 6/6 NYLON UL94-V0 BLACK  
PIN : PHOSPHOR BRONZE
    - PART (B) (EJECT MECHANISM ASS'Y)  
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK  
: PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK  
PLATE : STAINLESS  
EMI CONTACT: PHOSPHOR BRONZE
  - FINISH (PIN)  
UNDER PLATING : 0.5µm MIN. NI  
CONTACT AREA : 0.1µm MIN. GOLD OVER 0.5µm MIN. Pd-Ni  
SOLDER TAIL : 2.5µm MIN. Sn-Pb  
: 2.5µm MIN. PURE Sn ( FOR -\*\*\*\*\*LF )

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68

- △NUT M2\*0.4P (2X) RETENTION FORCE : 1Kg MIN.
- IF LEAD FREE P/N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
  - IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
  - LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



mat'l code		tolerance unless otherwise specified		CUSTOMER COPY		<b>FCI</b>		www.fciconnect.com	
rev.	ecn no.	dr	date	linear	0. ± 0.50 .0 ± 0.30 .00 ± 0.15	projection	title 68POS. EJECTOR HEADER ASS'Y FOR TYPE 1/2/3		
K				angles	± 2°		product family		code
		dr	WENDY CHEN	08/15/95	unit	mm/inch	size		TWN
		enr	JOSEPH HSIA	08/15/95	scale	1.5:1	dwg no.		sheet
		chr	JOSEPH HSIA	08/15/95			A3		110F
		appd	JENN TSAO	08/15/95			94721		
sheet	revision								
index	sheet								

